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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

11-27-00

Takashi MIIDA

Additional name(s) of conveying party(ies) attached?  Yes  No

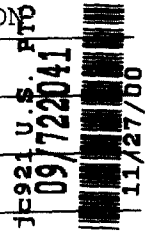
2. Name and address of receiving party(ies)

Name: INNOTECH CORPORATION

Internal Address: \_\_\_\_\_

Street Address: 3-17-6 Shinyokohama  
Kouhoku-ku, Yokohama-shi, 222-8580  
JAPAN  
City: \_\_\_\_\_ State: \_\_\_\_\_ ZIP: \_\_\_\_\_

Additional name(s) & address(es) attached?  Yes  No



3. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other \_\_\_\_\_

Execution Date: 15 NOV 2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 15 NOV 00

A. Patent Application No.(s)

B. Patent No.(s)

11/29/2000 JBALINAM 00000022 09722041

02 FC:581

40.00 OP

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: George A. Loud

Internal Address: \_\_\_\_\_

Street Address: LORUSSO & LOUD

3137 Mt. Vernon Avenue

City: Alexandria State: VA ZIP: 22305

6. Total number of applications and patents involved:

7. Total fee (37 CFR 3.41).....\$ 40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number: \_\_\_\_\_

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

George A. Loud  
Name of Person Signing

Signature

27 NOV 2000

Date

Total number of pages including cover sheet, attachments, and document:

Mail documents to be recorded with required cover sheet information to:  
Commissioner of Patents & Trademarks, Box Assignments

ASSIGNMENT

WHEREAS, WE, Takashi MIIDA  
of, respectively, c/o INNOTECH CORPORATION, 3-17-6 Shinyokohama  
Kouhoku-ku, Yokohama-shi, 222-8580, Japan

have invented certain improvements in "SOLID STATE IMAGING DEVICE, MANUFACTURING  
METHOD THEREOF, AND SOLID STATE IMAGING APPARATUS" set forth in  
an application for Letters Patent of the United States; and

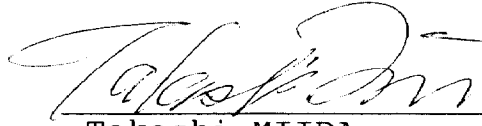
WHEREAS, INNOTECH CORPORATION  
of 3-17-6 Shinyokohama Kouhoku-ku, Yokohama-shi, 222-8580, Japan  
is desirous of acquiring an interest therein;

NOW THEREFORE, for and in consideration of the sum of  
One Dollar (\$1.00) and other good and valuable consideration, the  
receipt of which is hereby acknowledged, we, Takashi MIIDA

by these presents do sell, assign and transfer unto said \_\_\_\_\_  
INNOTECH CORPORATION its  
successors, legal representatives, heirs and assigns, the full  
and exclusive right, title and interest in the United States of  
America said application executed on the 15th day of  
November, 2000, (and we hereby authorize my attorneys,  
authorized to prosecute said application, to here insert the  
filing date and serial number of said application, when known:  
Serial No. \_\_\_\_\_ Filed \_\_\_\_\_) to all Letters

Patents in the United States which may be granted on said application, to all divisions, continuations and continuations-in-part of said application, or reissues or extensions of said Letters Patent, all applications for Letters Patent and all Letters Patent therefor, to be held and enjoyed by \_\_\_\_\_  
INNOTECH CORPORATION for its use and behoof and for its legal representatives, successors, heirs, and assigns, to the full end of the term for which said Letters Patent are granted and any extensions thereof, as fully and entirely as the same would have been held by us had this assignment and sale not been made; and for the same consideration, we hereby covenant and agree that, at the time of execution and delivery of this instrument, we hold good and full right and lawful authority to sell and convey the application for Letters Patent above mentioned in the manner herein set forth; and for the same consideration we hereby covenant and agree that we will, whenever counsel of INNOTECH CORPORATION or the counsel of its successors, legal representatives, heirs or assigns, shall advise that any proceeding in connection with said application for Letters Patent, or any proceeding in connection with Letters Patent in the United States, including interference proceedings, is lawful and desirable, or that any division, continuation or continuation-in-part of any application for Letters Patent, or any reissue or extension of any Letters Patent to be obtained thereon, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary

or required to be done for the procurement, maintenance,  
enforcement and defense of said Letters Patent, without charge to  
us, our successors, legal representatives, heirs and assigns, but  
at the cost and expense of INNOTECH CORPORATION its  
successors, legal representatives, heirs and assigns; and we  
hereby request the Commissioner of Patents to issue said Letters  
Patent to INNOTECH CORPORATION as assignee thereof.



Takashi MIIDA

Nov. 15, 2000  
date

\_\_\_\_\_  
date

\_\_\_\_\_  
date